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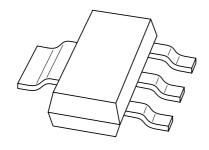
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



BSP126

N-channel enhancement mode vertical D-MOS transistor

Product specification Supersedes data of 1997 Jun 23 2002 Feb 19





N-channel enhancement mode vertical D-MOS transistor

BSP126

FEATURES

- Direct interface to C-MOS, TTL, etc.
- High-speed switching
- No secondary breakdown.

APPLICATIONS

- Line current interruptor in telephone sets
- Relay, high-speed and line transformer drivers.

DESCRIPTION

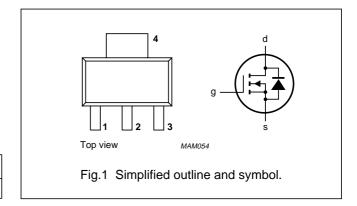
N-channel enhancement mode vertical D-MOS transistor in a miniature SOT223 package.

MARKING

TYPE NUMBER	MARKING CODE		
BSP126	BSP126		

PINNING - SOT223

PIN	DESCRIPTION
1	gate
2	drain
3	source
4	drain



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V_{DS}	drain-source voltage (DC)		_	250	V
I _D	drain current (DC)		_	375	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	1.5	W
R _{DSon}	drain-source on-state resistance	$I_D = 300 \text{ mA}; V_{GS} = 10 \text{ V}$	2.8	5	Ω
V_{GSth}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}$	_	2	V

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage (DC)		_	250	V
V _{GSO}	gate-source voltage (DC)	open drain	_	±20	V
I _D	drain current (DC)		_	375	mA
I _{DM}	peak drain current		_	1.3	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	1.5	W
T _{stg}	storage temperature		-55	+150	°C
T _j	junction temperature		_	150	°C

Note

1. Device mounted on a $40 \times 40 \times 1.5$ mm epoxy printed-circuit board; mounting pad for the drain tab minimum 6 cm².

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient; note 1	83.3	K/W

Note

1. Device mounted on a $40 \times 40 \times 1.5$ mm epoxy printed-circuit board; mounting pad for the drain tab minimum 6 cm².

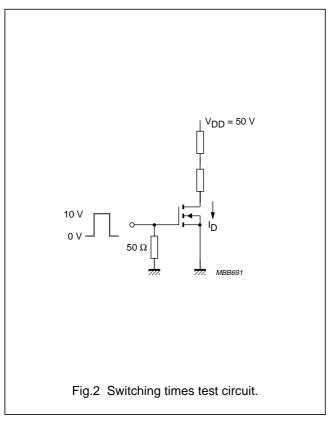
CHARACTERISTICS

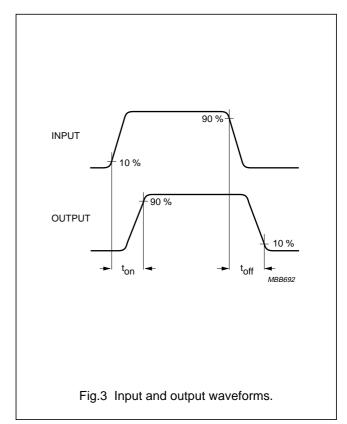
 $T_i = 25$ °C unless otherwise specified.

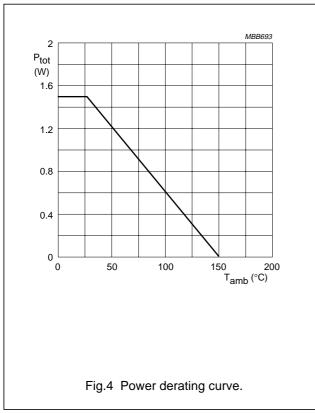
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 10 \mu A; V_{GS} = 0$	250	_	_	V
I _{GSS}	gate-source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$	_	-	±100	nA
V_{GSth}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}$	0.8	_	2	٧
R _{DSon}	drain-source on-state resistance	$I_D = 20 \text{ mA}; V_{GS} = 2.4 \text{ V}$	_	_	7.5	Ω
		$I_D = 300 \text{ mA}; V_{GS} = 10 \text{ V}$	_	2.8	5	Ω
I _{DSS}	drain-source leakage current	V _{DS} = 200 V; V _{GS} = 0	_	_	1	μΑ
Y _{fs}	transfer admittance	I _D = 300 mA; V _{DS} = 25 V	200	600	_	mS
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0; f = 1 MHz	_	100	120	pF
C _{oss}	output capacitance	$V_{DS} = 25 \text{ V}; V_{GS} = 0; f = 1 \text{ MHz}$	_	21	30	pF
C _{rss}	feedback capacitance	$V_{DS} = 25 \text{ V}; V_{GS} = 0; f = 1 \text{ MHz}$	_	10	15	pF
Switching tin	Switching times (see Figs 2 and 3)					
t _{on}	turn-on time	I_D = 250 mA; V_{DD} = 50 V; V_{GS} = 0 to 10 V	_	6	10	ns
t _{off}	turn-off time	I _D = 250 mA; V _{DD} = 50 V; V _{GS} = 10 to 0 V	_	47	60	ns

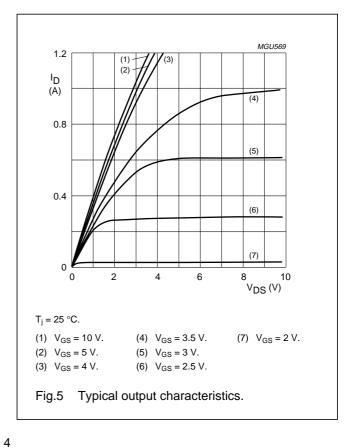
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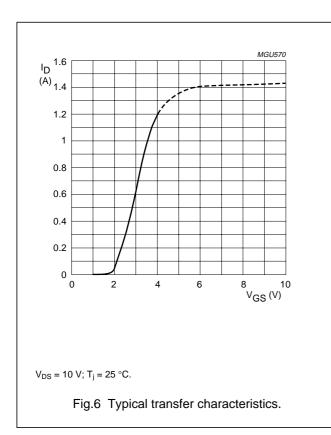


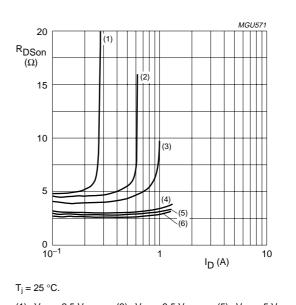


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(1) $V_{GS} = 2.5 \text{ V}.$

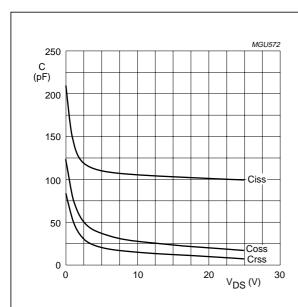
(3) $V_{GS} = 3.5 \text{ V}.$

(5) $V_{GS} = 5 \text{ V}$. (6) $V_{GS} = 10 \text{ V}$.

(2) $V_{GS} = 3 V$.

(4) $V_{GS} = 4 V$.

Fig.7 Drain-source on-state resistance as a function of drain current; typical values.

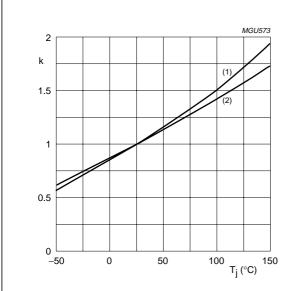


 V_{GS} = 0; f = 1 MHz; T_j = 25 °C.

Fig.8 Input, output and feedback capacitance as functions of drain-source voltage; typical values.

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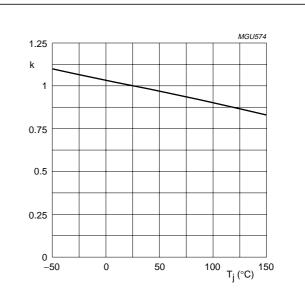
$$k = \frac{R_{DSon} at T_j}{R_{DSon} at 25 °C}$$

Typical R_{DSon:}

(1) $I_D = 250 \text{ mA}$; $V_{GS} = 10 \text{ V}$.

(2) $I_D = 20 \text{ mA}$; $V_{GS} = 2.4 \text{ V}$.

Fig.9 Temperature coefficient of drain-source on-state resistance; typical values.



$$k = \frac{V_{GSth} \text{ at } T_j}{V_{GSth} \text{ at 25 } ^{\circ}C}$$

Typical V_{GSth} at 1 mA.

Fig.10 Temperature coefficient of gate-source threshold voltage; typical values.

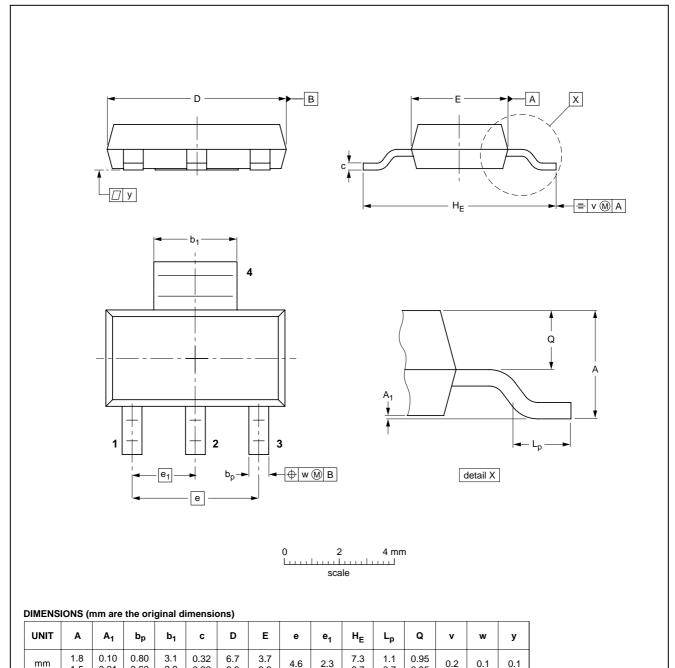
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION ISSUE DA	
SOT223			SC-73			97-02-28 99-09-13

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1.5

0.01

0.60

2.9

0.22

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DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

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NOTES

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NOTES

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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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